

March 1999 Revised November 2000

74LVT574 • 74LVTH574 Low Voltage Octal D-Type Flip-Flop with 3-STATE Outputs

General Description

The LVT574 and LVTH574 are high-speed, low-power octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-STATE outputs for bus-oriented applications. A buffered Clock (CP) and Output Enable (\overline{OE}) are common to all flip-flops.

The LVTH574 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These octal flip-flops are designed for low-voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT574 and LVTH574 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

Features

- \blacksquare Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH574), also available without bushold feature (74LVT574).
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 574
- Latch-up performance exceeds 500 mA
- ESD performance:

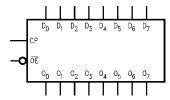
Human-body model > 2000V Machine model > 200V Charged-device model > 1000V

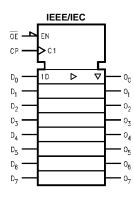
Ordering Code:

Order Number	Package Number	Package Description
74LVT574WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74LVT574SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVT574MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74LVT574MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74LVTH574WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74LVTH574SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVTH574MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74LVTH574MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

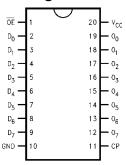
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbols





Connection Diagram



Pin Descriptions

Pin Names	Description
D ₀ -D ₇	Data Inputs
CP	Clock Pulse Input
ŌE	3-STATE Output Enable Input
O ₀ -O ₇	3-STATE Outputs

Truth Table

	Outputs		
D _n	СР	ŌĒ	O _n
Н	~	L	Н
L	~	L	L
X	L	L	O _o
X	Х	Н	Z

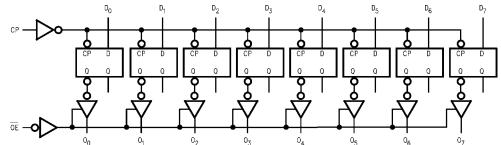
H = HIGH Voltage Level

Functional Description

The LVT574 and LVTH574 consist of eight edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The buffered clock and buffered Output Enable are common to all flip-flops. The eight flip-flops will store the state of their individual D-type inputs that meet the setup and hold time requirements on the LOW-to-HIGH

Clock (CP) transition. With the Output Enable (OE) LOW, the contents of the eight flip-flops are available at the outputs. When the OE is HIGH, the outputs go to the high impedance state. Operation of the $\overline{\text{OE}}$ input does not affect the state of the flip-flops.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

= LOW-to-HIGH Transition

O_o = Previous O_o before HIGH to LOW of CP

Absolute Maximum Ratings(Note 1) Symbol Parameter Value Conditions Units -0.5 to +4.6 ٧ Supply Voltage V_{CC} ٧ DC Input Voltage -0.5 to +7.0 V_{I} Vo DC Output Voltage -0.5 to +7.0 Output in 3-STATE ٧ Output in HIGH or LOW State (Note 2) -0.5 to +7.0 DC Input Diode Current -50 $V_I < GND$ mΑ I_{IK} DC Output Diode Current -50 V_O < GND mΑ I_{OK} DC Output Current 64 V_O > V_{CC} Output at HIGH State I_{O} $\mathsf{m}\mathsf{A}$ 128 Output at LOW State I_{CC} DC Supply Current per Supply Pin ±64 mΑ DC Ground Current per Ground Pin ±128 mΑ I_{GND} Storage Temperature -65 to +150 °C T_{STG}

Recommended Operating Conditions

Symbol	Parameter		Max	Units
V _{CC}	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
I _{OH}	HIGH-Level Output Current		-32	mA
I _{OL}	LOW-Level Output Current		64	mA
T _A	Free-Air Operating Temperature	-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = 3.0V	0	10	ns/V

Note 1: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 2: Io Absolute Maximum Rating must be observed.

DC Electrical Characteristics

	Parameter		.,	T _A :	= -40°C to +8	35°C		
Symbol			V _{CC} (V)	Min	Typ (Note 3)	Max	Units	Conditions
V _{IK}	Input Clamp Diode	Voltage	2.7		, ,	-1.2	V	I _I = -18 mA
V _{IH}	Input HIGH Voltage		2.7-3.6	2.0			V	V _O ≤ 0.1V or
V _{IL}	Input LOW Voltage		2.7-3.6			0.8	V	$V_{O} \ge V_{CC} - 0.1V$
V _{OH}	Output HIGH Voltag	e	2.7-3.6	V _{CC} - 0.2				$I_{OH} = -100 \mu A$
			2.7	2.4			V	$I_{OH} = -8 \text{ mA}$
			3.0	2.0				$I_{OH} = -32 \text{ mA}$
V _{OL}	Output LOW Voltage	е	2.7			0.2		$I_{OL} = 100 \mu A$
			2.7			0.5		I _{OL} = 24 mA
			3.0			0.4	V	I _{OL} = 16 mA
			3.0			0.5		I _{OL} = 32 mA
			3.0			0.55		I _{OL} = 64 mA
I _{I(HOLD)}	Bushold Input Minin	num Drive	3.0	75			μА	$V_{I} = 0.8V$
(Note 4)				-75				V _I = 2.0V
I _{I(OD)}	Bushold Input Over-	-Drive	3.0	500			μА	(Note 5)
(Note 4)	Current to Change S	State		-500			μΑ	(Note 6)
I _I	Input Current		3.6			10		V _I = 5.5V
		Control Pins	3.6			±1	μА	$V_I = 0V$ or V_{CC}
		Data Pins	3.6			-5	μΑ	$V_I = 0V$
		Data Filis	3.0			1		$V_I = V_{CC}$
I _{OFF}	Power Off Leakage	Current	0			±100	μΑ	$0V \le V_I \text{ or } V_O \le 5.5V$
I _{PU/PD}	Power Up/Down 3-STATE Output Current		0-1.5V			±100	μА	$V_O = 0.5V$ to 3.0V $V_I = GND$ or V_{CC}
I _{OZL}	3-STATE Output Le	akage Current	3.6			-5	μΑ	$V_0 = 0.5V$
I _{OZH}	3-STATE Output Le	akage Current	3.6			5	μА	V _O = 3.0V

DC Electrical Characteristics (Continued)

		v _{cc}	T _A = -40°C to +85°C				
Symbol	Parameter	(V)	Min	Typ (Note 3)	Max	Units	Conditions
I _{OZH} +	3-STATE Output Leakage Current	3.6			10	μΑ	$V_{CC} < V_O \le 5.5V$
Гссн	Power Supply Current	3.6			0.19	mA	Outputs High
I _{CCL}	Power Supply Current	3.6			5	mA	Outputs Low
I _{CCZ}	Power Supply Current	3.6			0.19	mA	Outputs Disabled
I _{CCZ} +	Power Supply Current	3.6			0.19	mA	V _{CC} ≤ V _O ≤ 5.5V, Outputs Disabled
Δl _{CC}	Increase in Power Supply Current	3.6			0.2	mA	One Input at V _{CC} – 0.6V
	(Note 7)						Other Inputs at V _{CC} or GND

Note 3: All typical values are at $V_{CC} = 3.3V$, $T_A = 25$ °C.

Note 4: Applies to bushold versions only (74LVTH574).

Note 5: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 6: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 7: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 8)

	Symbol	Parameter	V _{CC} T _A = 25°C		Units	Conditions		
Symbol	Зушьы	Farameter	(V)	Min	Тур	Max	Units	$\textbf{C}_{\textbf{L}} = \textbf{50}~\text{pF,}~\textbf{R}_{\textbf{L}} = \textbf{500}\Omega$
	V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		V	(Note 9)
	V _{OLV}	Quiet Output Minimum Dynamic VOL	3.3		-0.8		V	(Note 9)

Note 8: Characterized in SOIC package. Guaranteed parameter, but not tested.

Note 9: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

AC Electrical Characteristics

		$T_A = -40^{\circ}\text{C}$ to +85°C $C_L = 50$ pF, $R_L = 500\Omega$						
Symbol	Parameter		$V_{CC} = 3.3V \pm 0.3$	V _{CC} = 2.7V		Units		
		Min	Typ (Note 10)	Max	Min	Max		
f _{MAX}	Maximum Clock Frequency	150			150		MHz	
t _{PHL}	Propagation Delay	1.8		4.6	1.8	5.3		
t _{PLH}	CP to O _n	1.8		4.5	1.8	5.3	ns	
t _{PZL}	Output Enable Time	1.5		5.2	1.5	6.1		
t _{PZH}		1.5		4.8	1.5	5.9	ns	
t _{PLZ}	Output Disable Time	2.0		4.4	2.0	4.4		
t _{PHZ}		2.0		4.8	2.0	5.1	ns	
t _S	Setup Time	2.0			2.4		ns	
t _H	Hold Time	0.3			0.0		ns	
t _W	Pulse Width	3.3			3.3		ns	
t _{OSHL}	Output to Output Skew (Note 11)			1.0		1.0	no	
t _{OSLH}				1.0		1.0	ns	

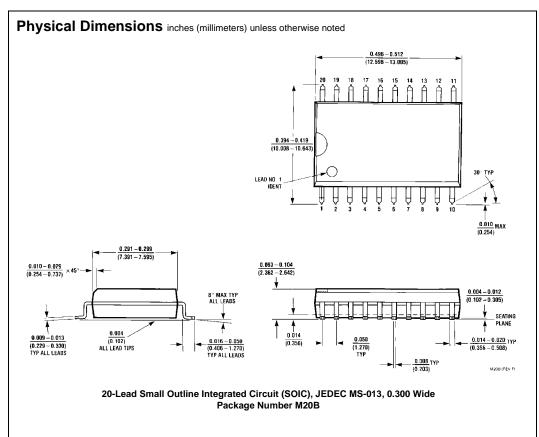
Note 10: All typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$.

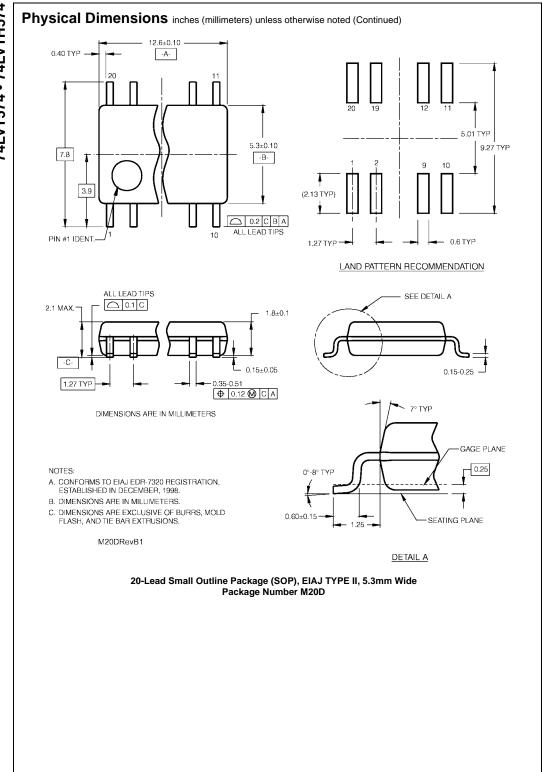
Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH to LOW (t_{OSHL}) or LOW to HIGH (t_{OSLH}).

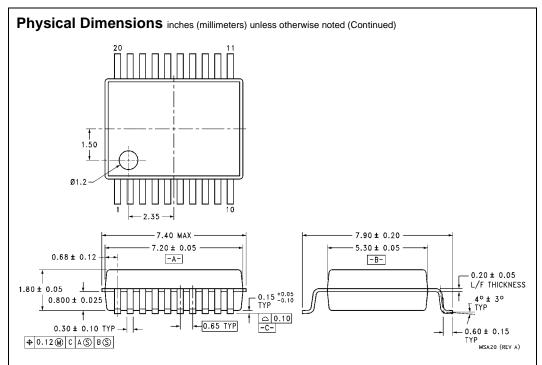
Capacitance (Note 12)

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	V _{CC} = Open, V _I = 0V or V _{CC}	4	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.0V$, $V_O = 0V$ or V_{CC}	6	pF

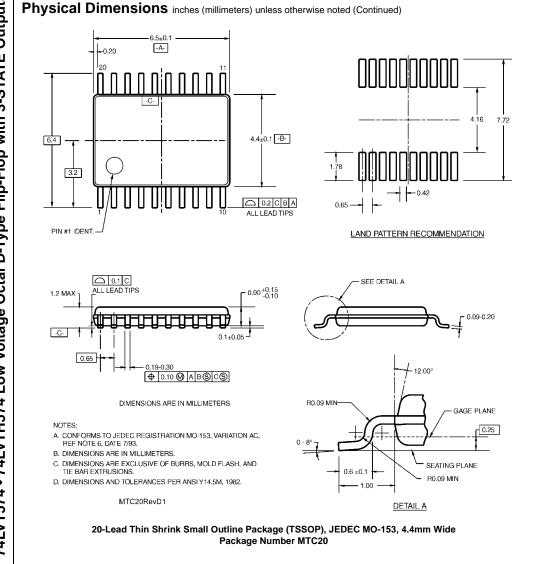
Note 12: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.







20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide Package Number MSA20



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